

Product data sheet

# 1. General description

Hyperfast power diode bare die.

## 2. Features and benefits

- Fast switching
- Low forward voltage drop
- Soft recovery characteristic
- Bare die

## 3. Quick reference data

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Table 1. Quie	ck reference data					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>RRM</sub> *	repetitive peak reverse voltage		-	-	600	V
I <sub>F(AV)</sub> **	average forward current	$\delta$ = 0.5 ; square-wave pulse	-	-	2	A
Static chara	acteristics		· ·			
V <sub>F</sub> **	forward voltage	I <sub>F</sub> = 1 A; T <sub>j</sub> = 25 °C	-	1.25	1.7	V
		I <sub>F</sub> = 2 A; T <sub>j</sub> = 25 °C	-	-	2	V
Dynamic ch	aracteristics	·	· · ·			
t <sub>rr</sub> **	reverse recovery time	I <sub>F</sub> = 1A; dI <sub>F</sub> /dt = 100 A/μs; V <sub>R</sub> = 30 V; T <sub>j</sub> = 25 °C;	-	30	-	ns

# 4. Ordering information

### Table 2.Ordering information

Type number	Package				
	Name	Description	Version		
WNB051C5APTS	Wafer	Bare die on wafer	Die		

# 5. Limiting values

### Table 2. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>RRM</sub> *	repetitive peak reverse voltage		-	600	V
V <sub>RWM</sub> *	crest working reverse voltage		-	600	V
V <sub>R</sub> *	reverse voltage	DC	-	600	V
I <sub>F(AV)</sub> **	average forward current	$\delta$ = 0.5 ; square-wave pulse	-	1	А
I <sub>FRM</sub> **	repetitive peak forward current	$\delta$ = 0.5 $ ;  t_p$ = 25 $\mu s ;  square-wave  pulse$	-	2	A
I <sub>FSM</sub> **	non-repetitive peak	$t_p$ = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse	-	10	А
	forward current	$t_p$ = 8.3 ms; $T_{j(init)}$ = 25 °C; square-wave pulse	-	11	A
T <sub>stg</sub> **	storage temperature		-65	175	°C
T <sub>j</sub> **	junction temperature		-	175	°C

### 6. Characteristics

Table 3. Chara	acteristics						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Static characteristics							
V <sub>F</sub> **	forward voltage	I <sub>F</sub> = 1 A; T <sub>j</sub> = 25 °C		-	1.25	1.7	V
		I <sub>F</sub> = 2 A; T <sub>j</sub> = 25 °C		-	-	2	V
I <sub>R</sub>	reverse current	V <sub>R</sub> = 600 V; T <sub>j</sub> = 25 °C		-	-	10	μA
		V <sub>R</sub> = 600 V; T <sub>j</sub> = 125 °C		-	-	0.2	mA
Dynamic cha	racteristics						
t <sub>rr</sub> **	reverse recovery time	$I_F$ = 1A; dI <sub>F</sub> /dt = 100 A/µs; V <sub>R</sub> = 30 V; T <sub>j</sub> = 25 °C;		-	30	-	ns

Notes:

(1) \* mean that parameter are 100% test at  $T_{amb}$  = 25.

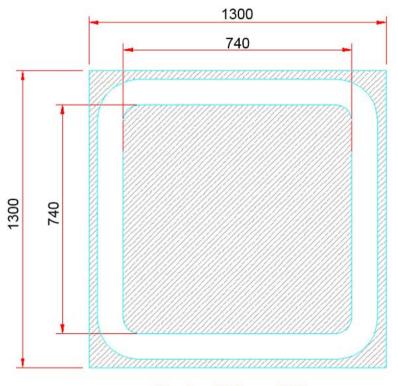
(2) \*\* means that the guaranteed ratings and parameter limits will depend on the assembled structure. When correctly assembled with suitable die bonding and wire bonding, the device will have ratings and characteristics guaranteed in this data sheet.

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### MECHANICAL PARAMETER

Chip size	1.3 x 1.3	mm²
Anode pad size	0.74 x 0.74	mm²
Area total /active	1.69 / 0.55	mm²
Thickness	300	μm
Wafer size	125	mm
Max possible chips per wafer	6732	pcs
Passivation	Glass	
Front metal	Al	
Back metal	Ti Ni Ag	

### CHIP LAYOUT



Die size: 1300um x 1300um Bond pad size: 740um x 740um

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## 7. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [ <u>3]</u>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

- [2] The term 'short data sheet' is explained in section "Definitions".
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